

**Hazardous Substance Table of SSD, Portable-SSD, module, Card Reader, UFD: 中国
产品中有毒有害物质或元素名**

部件名称	有毒有害物质或元素					
	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr ⁶⁺)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
元器件 (Component)	○	○	○	○	○	○
印刷电路板 (PCB)	○	○	○	○	○	○
锡膏 (Solder paste)	○	○	○	○	○	○
被动和主动设备 (Passive & Active Device)	X	○	○	○	○	○
附属部件 (Subsidiary parts)	○	○	○	○	○	○

根据 SJ/T 11364 编制了这个表格

This table was filled according to SJ/T 11364. 

○：表示该有毒有害物质在该部件所有均质材料中的含量均在 GB/T 26572 标准规定的限量要求以下。
Indicates that the concentration of the hazardous substance in all homogeneous materials in the parts is below the relevant threshold of the GB/T 26572 standard.

X：表示该有毒有害物质至少在该部件的某一均质材料中的含量超出 GB/T 26572 标准规定的限量要求。
Indicates that the concentration of the hazardous substance of at least one of all homogeneous materials in the parts is above the relevant threshold of the GB/T 26572 standard.

本表格提供的信息是基于供应商提供的数据及三星公司的检测结果，在当前技术水平下，所有有毒有害物质或元素的使用控制到了最底线。三星公司会继续努力通过改进技术来减少这些物质和元素的使用。
This table express inclusion information of hazardous chemical substances in device and information of hazardous chemical substances about each part is prepared on the authority of information that the cooperation company offers and result that we verify inside. Hazardous substance had included for some piece part is impossible to unuse by present technological level and Samsung Electronics make every effort to improvement this technological limits.

如果您有任何其他问题,请访问我们的网址
(<https://semiconductor.samsung.com/cn/sustainability/environment/green-chip/in-compliance-with-international-environmental-regulations/>).
If you have any further questions, please visit our Homepage
(<https://semiconductor.samsung.com/cn/sustainability/environment/green-chip/in-compliance-with-international-environmental-regulations/>).

Hazardous Substance Table of SSD, Portable-SSD, module, Card Reader, UFD: Taiwan

設備名稱：固態硬碟， 型號（型式）： 請參考外箱標籤						
單元Unit	限用物質及其化學符號					
	鉛 Lead (Pb)	汞 Mercury (Hg)	鎘 Cadmium (Cd)	六價鉻 Hexavalent chromium (Cr ⁺⁶)	多溴聯苯 Polybrominated biphenyls (PBB)	多溴二苯醚 Polybrominated diphenyl ethers (PBDE)
電子零組件	○	○	○	○	○	○
電路板	○	○	○	○	○	○
錫膏	○	○	○	○	○	○
主動及被動零組件	-	○	○	○	○	○
次要零組件	○	○	○	○	○	○
備考1. "○" 係指該項限用物質之百分比含量未超出百分比含量基準值。						
備考2. "-" 係指該項限用物質為排除項目。						